



SURFACE MOUNT SCHOTTKY BARRIER DIODE

Product Summary

V _{RRM} (V)	I _O (mA)	V _{F(MAX)} @ 1mA (V)	$I_{R(MAX)} @ V_R = 50V$ (µA)
70	70	0.41	0.1

Applications

- SMPS
- DC-DC Converter
- Freewheeling Diodes
- Reverse Polarity Protection
- Blocking Diodes

Features and Benefits

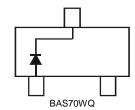
- Low Turn-on Voltage
- Fast Switching
- PN Junction Guard Ring for Transient and ESD Protection
- Ultra-Small Surface Mount Package
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP Capable (Note 4)

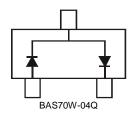
Mechanical Data

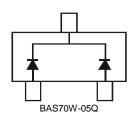
- Case: SOT323
- Case Material: Molded Plastic, "Green" Molding Compound, UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Terminals: Lead Free Plating (Matte Tin Finish Annealed over Alloy 42 Leadframe), Solderable per MIL-STD-202, Method 208 @3
- Polarity: See Diagrams Below
- Weight: 0.006 grams (Approximate)

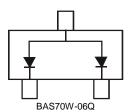


Top View









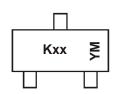
Ordering Information (Note 5)

Part Number	Case	Packaging
BAS70WQ-7-F	SOT323	3000/Tape & Reel
BAS70W-04Q-7-F	SOT323	3000/Tape & Reel
BAS70W-05Q-7-F	SOT323	3000/Tape & Reel
BAS70W-06Q-7-F	SOT323	3000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. Automotive products are AEC-Q101 qualified and are PPAP capable. Refer to http://www.diodes.com/product_compliance_definitions.html.
- 5. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



Kxx = Product Type Marking Code

K73 = BAS70WQ

K74 = BAS70W-04Q

K75 = BAS70W-05Q

K76 = BAS70W-06Q YM = Date Code Marking

Y = Year (ex: D = 2016)

M = Month (ex: 9 = September)

Date Code Key

_	Date Code N	key													
	Year	2010	2011	2012	2013	2014	2015	2016	2017	2018	2019	2020	202	1 2022	2023
	Code	X	Υ	Z	Α	В	С	D	Е	F	G	Н		J	K
	Month	Jan	Feb	Ma	ar .	Apr	May	Jun	Jul	Aug	Se	р	Oct	Nov	Dec
Ī	Code	1	2	3	3	4	5	6	7	8	9		0	N	D



Maximum Ratings (@ $T_A = +25$ °C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	70	٧
RMS Reverse Voltage	V _{R(RMS)}	49	V
Forward Continuous Current (Note 6)	l ₀	70	mA
Non-Repetitive Peak Forward Surge Current @ tp < 1.0s	I _{FSM}	100	mA

Thermal Characteristics

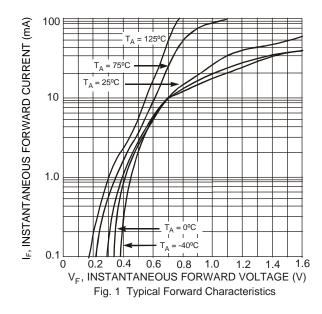
Characteristic	Symbol	Value	Unit
Power Dissipation (Note 6)	P_{D}	200	mW
Thermal Resistance Junction to Ambient Air (Note 6)	$R_{ heta JA}$	625	°C/W
Operating Temperature Range	TJ	-55 to +125	°C
Storage Temperature Range	T _{STG}	-65 to +150	°C

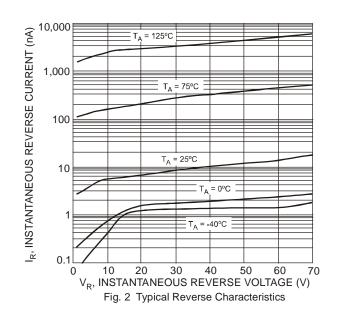
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 7)	$V_{(BR)R}$	70	_	_	$I_R = 10\mu A$
Forward Voltage	VF		410 1000	mV	$t_p < 300 \mu s, I_F = 1.0 mA$ $t_p < 300 \mu s, I_F = 15 mA$
Reverse Current (Note 7)	I_R		100	nA	$t_p < 300 \mu s$, $V_R = 50 V$
Total Capacitance	Ст	_	2.0	pF	$V_R = 0V$, $f = 1.0MHz$
Reverse Recovery Time		_	5.0	ns	$I_F = I_R = 10$ mA to $I_R = 1.0$ mA, $I_{RR} = 0.1 \times I_R$, $R_L = 100\Omega$

Notes:

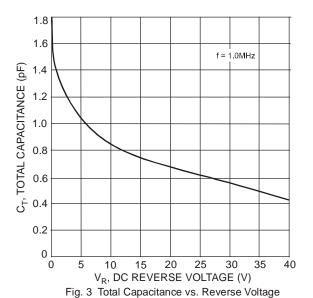
- 6. Device mounted on FR-4 PCB, 1 inch x 0.85 inch x 0.062 inch; pad layout as shown in Diodes Incorporated's package outline PDFs, which can be found on our website at http://www.diodes.com/package-outlines.html.
- 7. Short duration pulse test used to minimize self-heating effect.

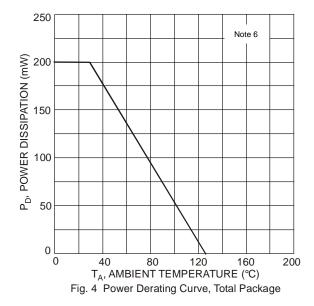










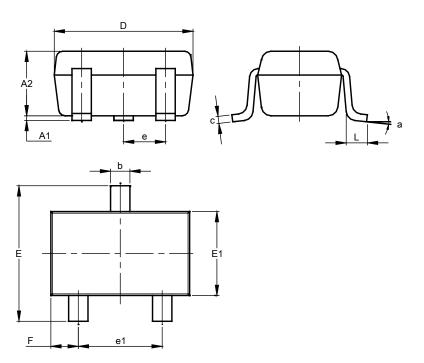




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT323

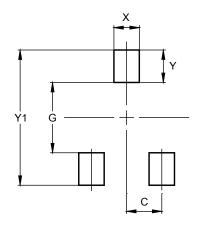


SOT323								
Dim	Min	Min Max Typ						
A1	0.00	0.10	0.05					
A2	0.90	1.00	0.95					
b	0.25	0.40	0.30					
С	0.10	0.18	0.11					
D	1.80	2.20	2.15					
Е	2.00	2.20	2.10					
E1	1.15	1.35	1.30					
е	0).650 B	SC					
e1	1.20	1.40	1.30					
F	0.375	0.475	0.425					
L	0.25	0.40	0.30					
а	0°	8°						
All Dimensions in mm								

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT323



Dimensions	Value (in mm)			
C	0.650			
G	1.300			
Х	0.470			
Y	0.600			
Y1	2 500			



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